



A1019/20276

Customer No. 03000

PATENT

444
1-7803
RECEIVED
JAN 24 2003

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE
PATENT EXAMINING OPERATION

Applicant : William John Waywood
Serial No. : 09/916,053
Confirmation No. : 7279
Filed : July 26, 2001
For : BIAXIALLY ORIENTED POLYOLEFIN
SLIP FILMS WITH IMPROVED
FLATNESS AND ADHESION
PROPERTIES
Group Art No. : 1771
Examiner : Daniel R. Zirker

TECHNOLOGY CENTER 1700

DECLARATION OF WILLIAM JOHN WAYWOOD

I, WILLIAM JOHN WAYWOOD, hereby make the following declaration.

1. At the time the above-captioned application was prepared, I made an erroneous assumption that coextruded, multilayer polyolefin films including an antistatic additive in an outer skin layer and a migratory amide in the core layer were known in the prior art. I made this assumption based upon my understanding that both antistatic additives and migratory amides were used in prior art multilayer polyolefin film structures.
2. After reviewing the most recent Office Action, which was mailed from the United States Patent and Trademark Office on October 31, 2002, I reviewed the acknowledgment of prior art set forth in the paragraph beginning on line 7 of page 3 and recognized that it was incorrect.

3. On information and belief, prior art, multilayer films including both a migratory amide and an antistatic additive in the same layer are known. However, I am not presently aware of any prior art, multilayer, polyolefin films in which an antistatic additive is employed in an outer skin layer and a migratory amide is employed in a core layer for any purpose, let alone to achieve the desired COF and adhesion properties desired for adhesive label applications, as in the present invention.

I, WILLIAM JOHN WAYWOOD, hereby declare that all statements made of my own knowledge are true and that all statements made on information and belief are believed to be true and that I have been warned that willful false statements and the like so made are punishable by fine or imprisonment, or both (18 U.S.C. 1001) and may jeopardize the validity of this application or any patent issuing thereon.



1-8-03

William John Waywood